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U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): Shine Chien Chung 11-19-04 Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies) Name: Taiwan Semiconductor Manufacturing Internal Address: Co., Ltd. Street Address: No. 8, Li-Hsin Road 6 Science Based Industrial Park, Hsin-Chu City: Taiwan State: Zip: ROC 300-77 Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance: [X] Assignment [] Merger [] Security Agreement [] Change of Name [] Other Execution Date: 9/17/04

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: 11/19/04 A. Patent Application No.(s) B. Patent No.(s) Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed: Name: Howard Chen Internal Address: Duane Morris LLP Street Address: One Market Street Spear Tower, Suite 2000 City: San Francisco State: CA Zip: 94105-1104

6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41).....\$ 40.00 [] Enclosed [X] Authorized to be charged to deposit account

8. Deposit account number: 04-1679

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9. Signature. Howard Chen, Reg. No. 46, 615 Name of Person Signing Signature Date 11/19/04

Total number of pages including cover sheet, attachments, and documents: 3

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

11/30/2004 GT0411 00000129 041679 10993711 FC:8021 40.00 DA

ASSIGNMENT AND AGREEMENT

For value received, I/we, **Shine Chien Chung** hereby sell, assign and transfer to **Taiwan Semiconductor Manufacturing Co., Ltd.**, with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **DECOUPLING CAPACITOR DESIGN** described in an application for Letters Patent of the United States filed on November 19, 2004 and bearing the Application Number _____ and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and I/we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/we authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me/us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/we hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/we request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

Assignment and Agreement 1

I/we agree that, when requested, I/we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1:

Dated: 9/17/2004 *Shine Chien Chung*
Shine Chien Chung

Residence: 5988 Porto Alegre Dr.
San Jose, CA 95120

Citizenship: USA

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